MMIC **REFLECTIONLESS FILTERS** 50Ω DC to 21 GHz

The Big Deal

•High Stopband rejection, up to 50 dB

•Patented design terminates stopband signals

•Pass band cut-off up to 11 GHz

•Stop band up to 26 GHz

• Excellent repeatability through IPD* process



Product Overview

Mini-Circuits' *X-Series* of reflectionless filters now includes 2- and 3-section models, giving you ultra-high rejection in the stopband – up to 50 dB! Reflectionless filters employ a patented filter topology which absorbs and terminates stopband signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stopband, sending signals back to the source at 100% power. These reflections interact with neighboring components and often result in intermodulation and other interferences. By eliminating stopband reflections, reflectionless filters can readily be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

Key Features	Advantages
Easy integration with sensitive reflective components, e.g. mixers, multipliers	Reflectionless filters absorb unwanted signals falling in filter stopband, preventing reflections back to the source. This reduces generation of additional unwanted signals without the need for extra components like attenuators, improving system dynamic range and saving board space.
High stopband rejection, up to 50 dB	Ideal for applications where suppression of strong spurious signals and intermod- ulation products is needed.
Enables stable integration of wideband amplifiers	Because reflectionless filters maintain good impedance in the stopband; they can be integrated with high gain, wideband amplifiers without the risk of creating instabilities in these out of band regions.
Cascadable	Reflectionless filters can be cascaded in multiple sections to provide sharper and higher attenuation, while also preventing any standing waves that could affect passband signals. Low & highpass filters can be cascaded to realize bandpass filters.
Excellent power handling in a tiny surface mount device up to 7W in passband	High power handling extends the usability of these filters to the transmit path for inter-stage filtering.
Small size, 3x3mm/ 4x4 mm/ 5x5mm QFN	Allows replacement of filter/attenuator pairs with a single reflectionless filter, saving board space.
Excellent repeatability of RF performance	Through semiconductor IPD process, X-series filters are inherently repeatable for large volume production.
Excellent stability over temperature	With ±0.3 dB variation over temperature ideal for use in wide temperature range applications without the need for additional temperature compensation.
Operating temperature up to 105°C	Suitable for operation close to high power components.

*IPD - Integrated Passive Device, is a GaAs semiconductor process

Reflectionless Low Pass Filter

XLF-362H+

50Ω DC to 3910 MHz

Features

- Match to 50Ω in the stop band, eliminates undesired reflections
- Cascadable
- Excellent stopband rejection, 48 dB typ.
- Temperature stable, up to 105°C
- Small size, 3 x 3 mm
- Protected by US Patents 8,392,495; 9,705,467, additional patent pending
- Protected by China Patent 201080014266.1
- Protected by Taiwan Patent I581494

Applications

- ISM Applications
- Mobile
- WiMAX
- Radio location



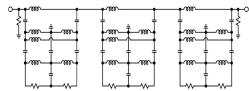
Generic photo used for illustration purposes only CASE STYLE: DQ1225

+RoHS Compliant The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

General Description

Mini-Circuits' XLF-362H+ three-section reflectionless filter employs a novel filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level. These reflections interact with neighboring components and often result in inter-modulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

simplified schematic and pad description



		NC	NC	NC		
	•	12	11	10		
GND	11	;		:	9	GND
RF-IN	2				8	RF-OUT
GND	3	!		!	7	GND
		4	5	6		
		NC	NC	NC		

Function	Pad Number	Description
RF-IN	2	RF Input Pad
RF-OUT	8	RF Output Pad
GND	1,3,7,9 & paddle	Connected to ground
NC (GND Externally)	4,5,6,10,11,12	No internal connection

Electrical Specifications¹ at 25°C

Parameter		F#	Frequency (MHz)	Min.	Тур.	Max.	Unit
	Insertion Loss	DC - F1	DC - 3910	—	1.3	2.1	dB
Pass Band	Frequency Cut-off	F2	6300	—	3.0	_	uв
	VSWR	DC - F1	DC - 3910	—	1.3	_	:1
			9200 - 10700	12	28	—	
	Rejection Stop Band VSWR	F3' - F4	10700 - 18500	35	48	_	dB
Sten Band		F4 - F5	18500 - 21000	_	50	_	
Stop Бапо		F3 - F3'	9200 - 10700	_	1.2	—	
		F3' - F4	10700 - 18500	—	1.4	_	:1
		F4 - F5	18500 - 21000		2.2		

¹ Measured on Mini-Circuits Characterization Test Board TB-844-362H+

Absolute Maximum Ratings⁴

Parameter	Ratings
Operating Temperature	-55°C to +105°C
Storage Temperature	-65°C to +150°C
RF Power Input, Passband (DC-F3) ²	4W at 25°C
RF Power Input, Stopband (F3-F5) ³	1.6W at 25°C

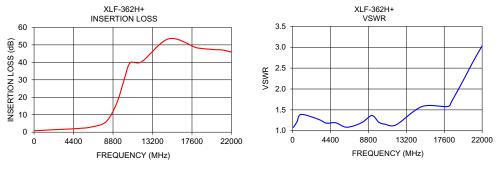
² Passband rating derates linearly to 2W at 105°C ambient

³ Stopband rating derates linearly to 0.8W at 105°C ambient ⁴ Permanent damage may occur if any of these limits are exceeded.

ESD rating

Human body model (HBM): Class 1A (Pass 250 V) in accordance with ANSI/ESD 5.1-2001

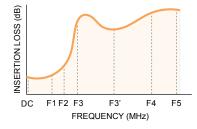
Typical Performance Data at 25°C Frequency (MHz) Insertion Loss VSWR (dB) (:1) 1.08 0.81 10 100 0.83 1.09 500 1000 0.91 1.21 1.39 1.27 1.09 3000 1.60 3910 1.80 1.18 5000 2.15 1.19 6300 2.89 1.08 8000 5.87 1.19 9200 16.43 1.36 10000 10700 29.34 1.21 1.16 39.66 12000 40.37 1.14 15000 18000 53.48 48.52 1.58 1.58 18500 48.02 1.72 20000 47.32 2.28 21000 47.05 45.88 2.67 22000 3.03



Mini-Circuits

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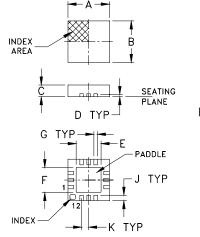
SPECIFICATION DEFINITION

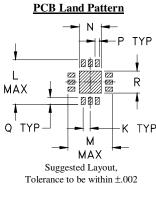


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Outline Drawing

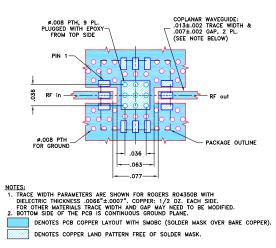




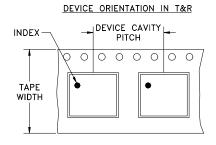
Outline Dimensions (inch)

J	н	G	F	Е	D	С	В	А
.016		.009	.057	.057	.008	.035	.118	.118
0.41		0.23	1.45	1.45	0.20	0.89	3.00	3.00
wt		R	Q	Р	Ν	М	L	к
wt grams				-	N .049		_	
		.049	.020	.010		.127	.127	.020

Demo Board MCL P/N: TB-844-362H+ Suggested PCB Layout: PL-451



Tape & Reel Packaging, F66



DIRECTION OF FEED

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note	
8	4	7	Small quantity standard	20 50 100 200 500
		7	Standard	1000, 2000

Lead Finish: Matte-Tin



Product Marking

